

■ SPECIFICATIONS

Item			Standard Type	Single Winding Latching Type	Double Winding Latching Type
			UM1-() W-K	UM1L-() W-K	UM1L-D () W-K
Contact	Arrangement		1 form C (SPDT)		
	Material		Gold clad (stationary contact), gold plate (movable contact)		
	Style		Bifurcated (cross bar)		
	Resistance (initial)		Maximum 100 mΩ		
	Rating (resistive)		10 mA 24 VDC 1 W (at 900 MHz)		
	Maximum Carrying Current		0.5 A		
	Maximum Switching Power		1 W (DC) 10 W (at 900 MHz)		
	Maximum Switching Voltage		30 VDC		
	Maximum Switching Current		100 mA		
	Minimum Switching Load*		0.01 mA 10 mVDC		
Excellent High Frequency Characteristics	Isolation		Minimum 60 dB (at 900 MHz), impedance of the measuring devices is 75Ω		
	Insertion Loss		Maximum 1 dB (at 900 MHz), impedance of the measuring devices is 75Ω		
	V.S.W.R.		Maximum 1.2 (at 900 MHz), impedance of the measuring devices is 75Ω		
Coil	Nominal Power (at 20°C)		200 to 220 mW	200 mW	400 mW
	Operate Power (at 20°C)		100 to 110 mW	100 mW	200 mW
	Operating Temperature		-30°C to +30°C (no frost)		
Time Value	Operate (at nominal voltage)		Maximum 6 ms	Maximum 6 ms (set)	
	Release (at nominal voltage)		Maximum 5 ms	Maximum 6 ms (reset)	
Life	Mechanical		1 × 10 ⁶ operations minimum		
	Electrical		3 × 10 ⁵ operations minimum (at nominal load)		
Other	Vibration	Misoperation	10 to 55 Hz (double amplitude of 3.3 mm)		
	Resistance	Endurance	10 to 55 Hz (double amplitude of 3.0 mm)		
	Shock	Misoperation	500 m/s ² (11 ±1 ms)		
	Resistance	Endurance	1,000 m/s ² (6 ±1 ms)		
	Weight		Approximately 4 g		

*1 Minimum switching loads mentioned above are reference values. Please perform the confirmation test with the actual load before production since reference values may vary according to switching frequencies, environmental conditions and expected reliability levels.

■ INSULATION

Item	Standard	Single latch	Double latch
Isolation (initial)	Minimum 1,000 MΩ (at 500VDC)		
Dielectric Strength	500VAC 1 min., (open contact / contact and shield terminals)		
	1,000VAC 1 min., (coil contact/ coil and shield terminals)		

■ COIL DATA CHART

MODEL		Nominal voltage	Coil resistance ($\pm 10\%$)	Must operate voltage*1	Must release voltage*1	Nominal power
Standard Type	UM1- 1.5 W-K	1.5 VDC	11.2 Ω	+1.05 VDC	+0.08 VDC	200 mW
	UM1- 3 W-K	3 VDC	45 Ω	+2.1 VDC	+0.15 VDC	200 mW
	UM1- 4.5 W-K	4.5 VDC	101 Ω	+3.15 VDC	+0.23 VDC	200 mW
	UM1- 5 W-K	5 VDC	125 Ω	+3.5 VDC	+0.25 VDC	200 mW
	UM1- 6 W-K	6 VDC	180 Ω	+4.2 VDC	+0.3 VDC	200 mW
	UM1- 9 W-K	9 VDC	405 Ω	+6.3 VDC	+0.45 VDC	200 mW
	UM1- 12 W-K	12 VDC	720 Ω	+8.4 VDC	+0.6 VDC	200 mW
	UM1- 18 W-K	18 VDC	1,620 Ω	+12.6 VDC	+0.9 VDC	200 mW
	UM1- 24 W-K	24 VDC	2,880 Ω	+16.8 VDC	+1.2 VDC	200 mW
	UM1- 48 W-K	48 VDC	10,472 Ω	+33.6 VDC	+2.4 VDC	220 mW

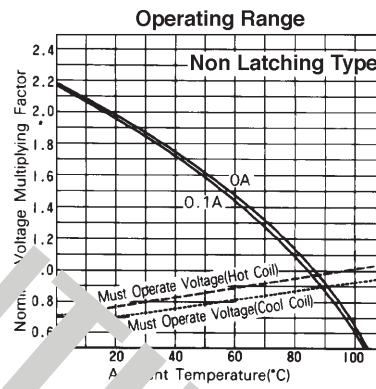
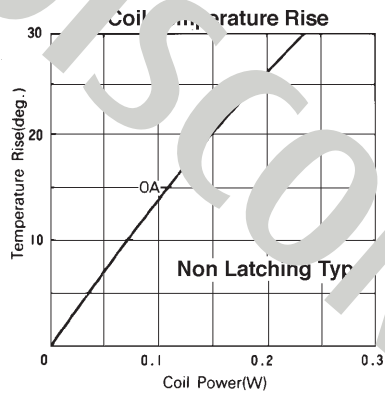
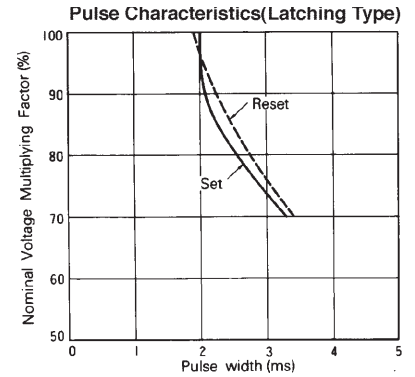
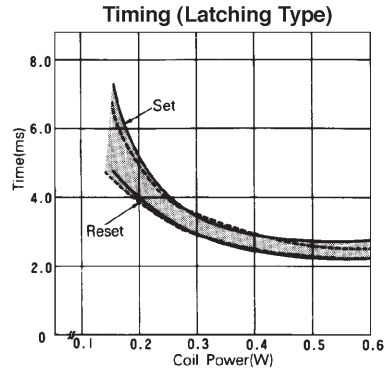
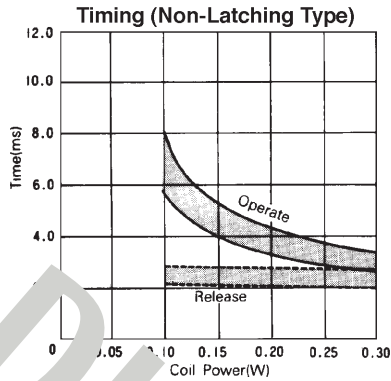
Note: *1 Specified values are subject to pulse wave voltage.
All values in the table are measured at 20°C.

	MODEL	Nominal voltage	Coil resistance (±10%)	Set voltage*1	Reset voltage*1	Nominal power
Single Winding Latching Type	UM1L- 1.5 W-K	1.5 VDC	11.2Ω	+1.05 VDC	-1.05 VDC	200 mW
	UM1L- 3 W-K	3 VDC	45 Ω	+2.1 VDC	-2.1 VDC	200 mW
	UM1L- 4.5 W-K	4.5 VDC	101 Ω	+3.15 VDC	-3.15 VDC	200 mW
	UM1L- 5 W-K	5 VDC	125 Ω	+3.5 VDC	-3.5 VDC	200 mW
	UM1L- 6 W-K	6 VDC	180 Ω	+4.2 VDC	-4.2 VDC	200 mW
	UM1L- 9 W-K	9 VDC	405 Ω	+6.3 VDC	-6.3 VDC	200 mW
	UM1L- 12 W-K	12 VDC	720 Ω	+8.4 VDC	-8.4 VDC	200 mW
	UM1L- 18 W-K	18 VDC	1,620 Ω	+12.6 VDC	-12.6 VDC	200 mW
	UM1L- 24 W-K	24 VDC	2,880 Ω	+16.8 VDC	-16.8 VDC	200 mW
	UM1L- 48 W-K	48 VDC	11,520 Ω	+33.6 VDC	-33.6 VDC	200 mW
Double Winding Latching Type	UM1L-D1.5 W-K	1.5 VDC	P 5.6Ω	+1.05 VDC		400 mW
			S 5.6Ω		+1.05 VDC	
	UM1L-D 3 W-K	3 VDC	P 22.5Ω	+2.1 VDC		400 mW
			S 22.5Ω		+2.1 VDC	
	UM1L-D4.5 W-K	4.5 VDC	P 50.6Ω	+3.15 VDC		400 mW
			S 50.6Ω		+3.15 VDC	
	UM1L-D 5 W-K	5 VDC	P 62.5Ω	+3.5 VDC		400 mW
			S 62.5Ω		+3.5 VDC	
	UM1L-D 6 W-K	6 VDC	P 90 Ω	+4.2 VDC		400 mW
			S 90 Ω		+4.2 VDC	
	UM1L-D 9 W-K	9 VDC	P 202.5Ω	+6.3 VDC		400 mW
			S 202.5Ω		+6.3 VDC	
	UM1L-D 12 W-K	12 VDC	P 360 Ω	+8.4 VDC		400 mW
			S 360 Ω		+8.4 VDC	
	UM1L-D 18 W-K	18 VDC	P 810 Ω	+12.6 VDC		400 mW
			S 810 Ω		+12.6 VDC	
	UM1L-D 24 W-K	24 VDC	P 1,440 Ω	+16.8 VDC		400 mW
			S 1,440 Ω		+16.8 VDC	
	UM1L-D 48 W-K	48 VDC	P 5,760 Ω	+33.6 VDC		400 mW
			S 5,760 Ω		+33.6 VDC	

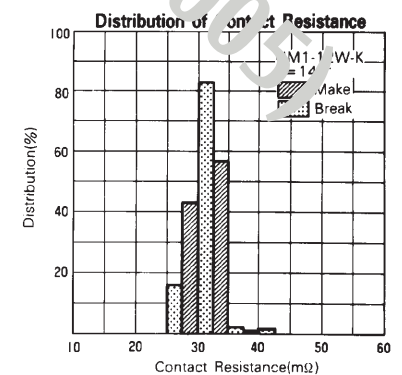
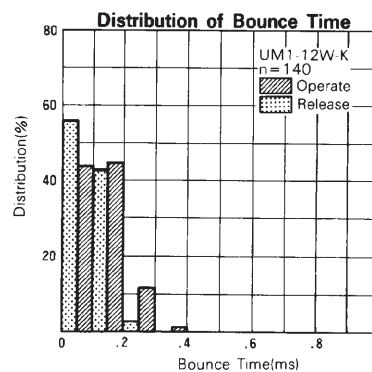
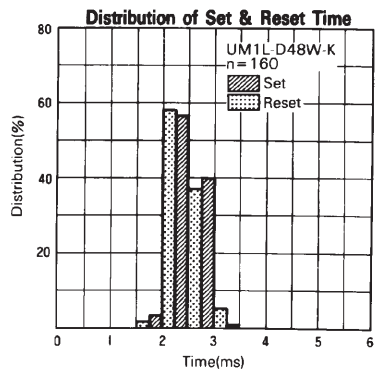
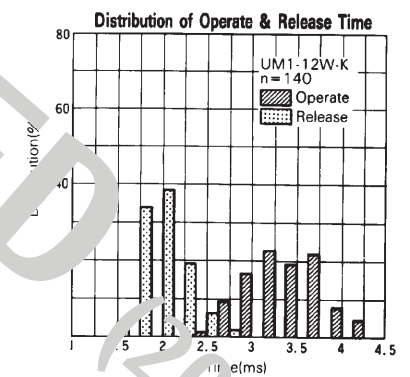
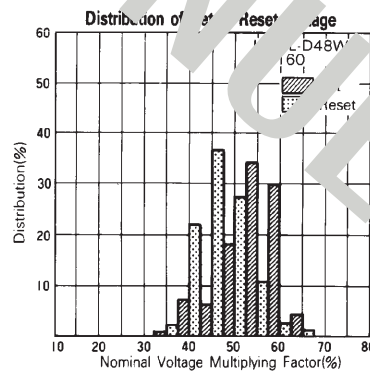
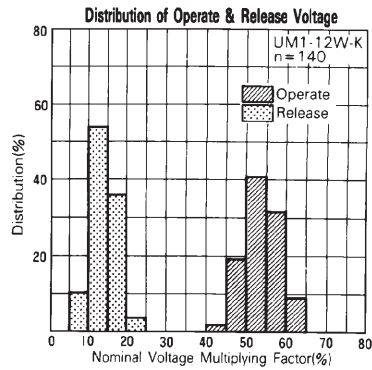
Note: *1 Specified values are subject to pulse wave voltage.
All values in the table are measured at 20°C.

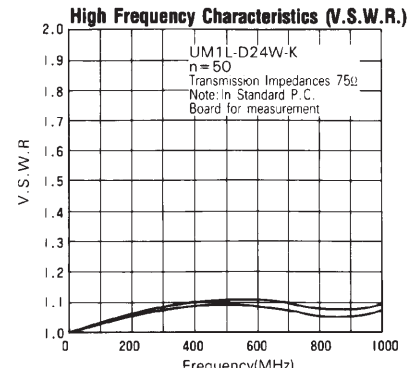
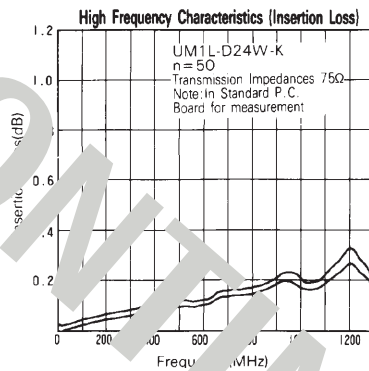
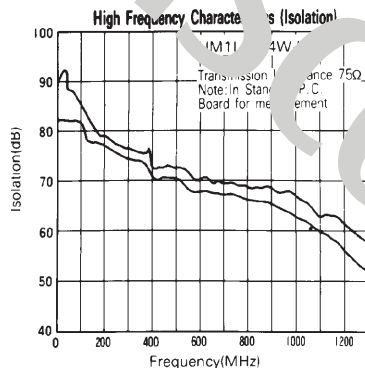
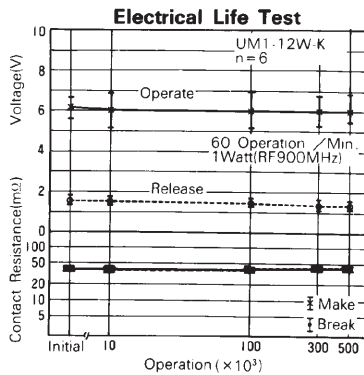
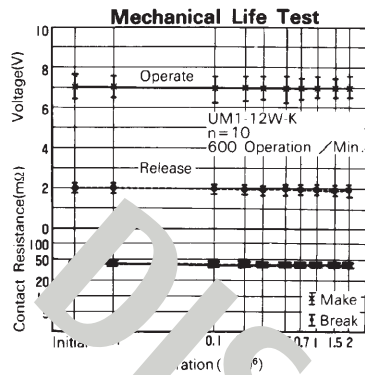
P: Primary coil S: Secondary coil

CHARACTERISTIC DATA



REFERENCE DATA





DIMENSIONS

Dimensions

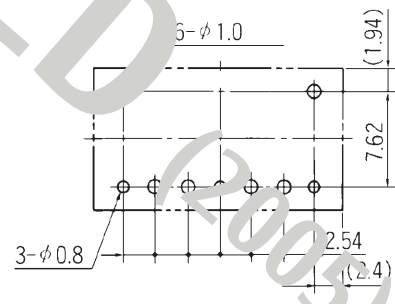
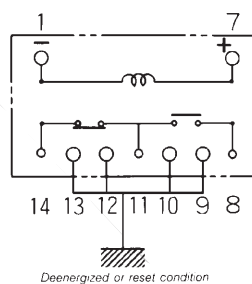
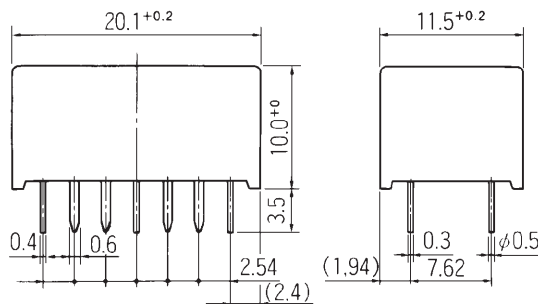
Schematics

(Bottom view)

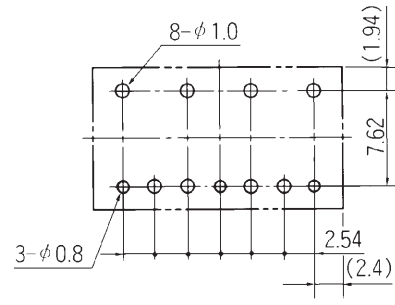
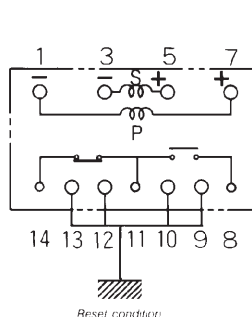
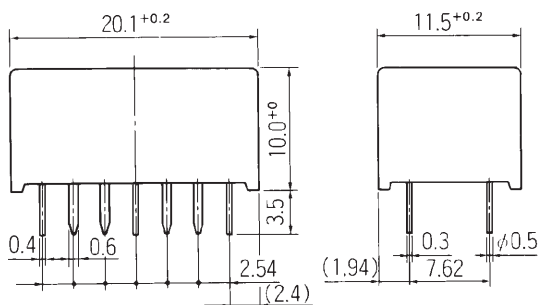
PC board

mounting hole layout
(Bottom view)

UM1, UM1L type (Non-latching type, single winding latching type)



UM1L-D type (Double winding latching type)



Unit: mm

RoHS Compliance and Lead Free Relay Information

1. General Information

- Relays produced after the specific date code that is indicated on each data sheet are lead-free now. All our signal and power relays are lead-free. Please refer to Lead-Free Status Info. (<http://www.fujitsu.com/us/downloads/MICRO/fcai/relays/lead-free-letter.pdf>)
- Lead free solder plating currently used in relays is Sn-3.0Ag-0.5Cu. From February 2005 forward Sn-3.0Ag-0.5Cu will be used for FTRB3 and FTR-B4 series relays.
- All signal and power relays also comply with RoHS. Please refer to individual data sheets. Relays that are RoHS compliant do not contain the 6 hazardous materials above the threshold level that are restricted by RoHS directive (lead, mercury, cadmium, chromium IV, PBB, PBDE and DecaBDE).
- It has been verified that using lead-free relays in leaded assembly process will not cause any problems (common lead).
- "LF" is marked on each outer and inner carton. (No marking on individual relays).

2. Recommended Lead Free Solder Profile

- Recommended solder paste Sn-3.0Ag-0.5Cu.

Solder condition

Flow Solder condition:

Pre-heating: maximum 120°C
Soldering: dip within 5 sec. at
260°C solder bath

Solder by Soldering Iron:

Soldering Iron
Temperature: maximum 360°C
Duration: maximum 3 sec.

We highly recommend that you confirm your actual solder conditions

3. Moisture Sensitivity

- Moisture Sensitivity Level standard is not applicable to electromechanical relays.

4. Tin Whisker

- Dipped SnAgCu solder is known as low risk tin whisker. No considerable whisker length was found by our in house test.

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Rev. December 23, 2008.